

## Press Fit Isolated Stud Mount Triac ½", 40 Amps

### Features

- Improved glass passivation for high reliability
- Exceptional stability at high temperatures
- Metric thread type available
- Low thermal resistance



**SC-66**

### **Electrical Characteristics ( $T_A = 25^\circ\text{C}$ unless otherwise specified)**

Parameter	Symbol	Part Numbers	Units
Maximum repetitive peak reverse voltage (1), $V_{RRM}$	200	NPIT402	V
	400	NPIT404	
	600	NPIT406	
RMS on-state current	$I_{T(RMS)}$	40	A
Non-repetitive peak surge on-state current, one cycle	$I_{TSM}$	400	A
Peak gate trigger current	$I_{GTM}$	12	A
Peak gate power dissipation @ $I_{GT} \leq I_{GTM}$	$P_{GM}$	40	W
Average gate power dissipation	$P_{G(AV)}$	0.75	W
Peak off-state current (1)	$I_{DRM} & I_{RRM}$	1.0	mA
Maximum instantaneous forward voltage drop (1)	$V_{TM}$	2.0	V
DC holding current (1)	$I_H$	60	mA
Critical rate-of-rise of off-state voltage (1)	Critical dv/dt	200	V/ $\mu$ sec
Critical rate-of-rise of commutation voltage (1)	Commutating dv/dt	3	V/ $\mu$ sec
DC gate trigger current	$I_{GT}$	100	mA
		150	
DC gate trigger voltage	$V_{GT}$	2.5	V
Gate controlled turn-on time	$T_{gt}$	3	$\mu$ sec

### **Thermal and Mechanical Specifications ( $T_A = 25^\circ\text{C}$ , unless otherwise noted)**

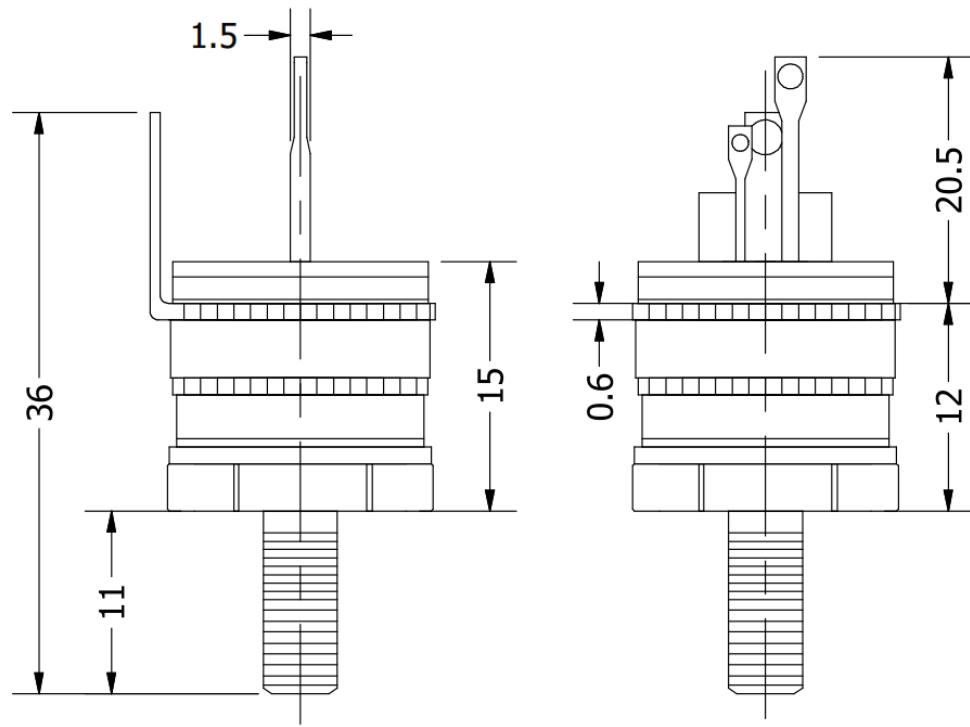
Parameters	Symbol	Values	Units
Maximum operating junction temperature range	$T_J$	- 40 to +110	$^\circ\text{C}$
Maximum storage temperature range	$T_{stg}$	- 40 to +150	$^\circ\text{C}$
Maximum thermal resistance, junction to case	$R_{\theta(J-C)}$	2.1	$^\circ\text{C}/\text{W}$
Approximate weight	W	30	g

Notes:

(1) All values apply in either direction

## Package Outline

(All dimensions in mm)



## Ordering Table

NPIT	40	2,4,6
1	2	3

1 – Press Fit Isolated Stud Mount Triac

2 – Current,  $I_{T(RMS)}$

3 – Voltage,  $V_{RRM}$  (See table)